



DOCKET NO.: 213260US0

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: :

Hans RIES, et al. :

SERIAL NO.: 10/024,379 :

FILED: December 21, 2001 :

FOR: POLYAMIDE COMPOSITE HAVING TWO OR MORE LAYERS

RECEIVED  
DEC-5 2002  
TC 1700 MAIL ROOM

**PRELIMINARY AMENDMENT**

ASSISTANT COMMISSIONER FOR PATENTS  
WASHINGTON, D.C. 20231

SIR:

Prior to examination on the merits, please amend the above-identified application as follows.

**IN THE SPECIFICATION**

Please amend the paragraph at page 5, lines 19-20 to read as follows:

wherein the molding composition of layer I is obtained by subjecting a blend  
A<sub>1</sub> comprising polyamide a) and polyamide c) to solid-phase post-condensation.

**IN THE CLAIMS**

Please amend Claim 32 as follows:

32. (Amended) A composite having two or more layers and comprising:

a layer I obtained from a molding composition comprising:

a) from 0 to 80 parts by weight of a polyamide selected from the group consisting  
of PA6, PA66, PA6/66 and a mixture thereof;

b) from 0 to 100 parts by weight of a polyamine-polyamide copolymer prepared